



IN THE US PATENT AND TRADEMARK OFFICE

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AUG 18 2003
TECHNOLOGY CENTER 2800

In re Application of:

Xiaochun Li et al.

Art Unit: 2874

Serial No: 09/597,966

Examiner: Valencia, Daniel

Filed: 06/20/2000

For: Embedded sensor, Method for producing, and remote temperature/strain fiber optic sensing System

I hereby certify that this correspondence is being deposited with the United States Postal Service as first class mail in an envelope addressed to: Commissioner of Patents and Trademarks, Washington, DC 20231, on


Signature

8/7/03
Date of deposit

Sarah Treat
Name of Person Signing

RESPONSE TO OFFICE ACTION

Commissioner of Patents and Trademarks
Washington, DC 20231

Sir:

The Applicants reply to the Office Action mailed 06/16/2003 as follows:

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